TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSVI)

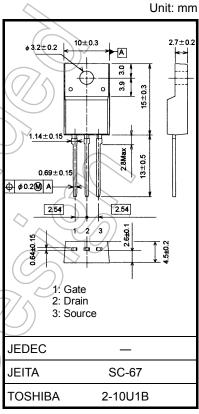
2SK3567

Switching Regulator Applications

- Low drain-source ON resistance: R_{DS} (ON) = 1.7 Ω (typ.)
- High forward transfer admittance: |Y_{fs}| = 2.5 S (typ.)
- Low leakage current: $I_{DSS} = 100 \mu A (max) (V_{DS} = 600 V)$
- Enhancement mode: V_{th} = 2.0 to 4.0 V (V_{DS} = 10 V, I_D = 1 mA)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	600	V
Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$)		V_{DGR}	600	A
Gate-source voltage		V_{GSS}	<u>±</u> 30	> v
Drain current	DC (Note 1)	ΙD	3.5	
	Pulse (t = 1 ms) (Note 1)	I _{DP}	14	A
Drain power dissipati	on (Tc = 25°C)	PD	35	<\\w
Single pulse avalance	ne energy (Note 2)	EAS	201	mJ
Avalanche current		TAR	3.5	(A
Repetitive avalanche	energy (Note 3)	EAR	3.5	/m/
Channel temperature		7) (Tch	150	°C
Storage temperature	range	T _{stg}	-55 to 150	→°C



Weight: 1.7 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

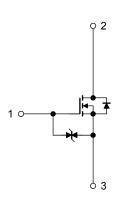
Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	3.57	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	62.5	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: $V_{DD} = 90 \text{ V}$, $T_{ch} = 25^{\circ}\text{C}(\text{initial})$, L = 28.8 mH, $I_{AR} = 3.5 \text{ A}$, $R_G = 25 \Omega$

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Please handle with caution.



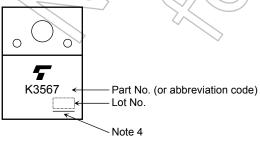
Electrical Characteristics (Ta = 25°C)

Char	acteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cui	rent	I _{GSS}	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μА
Gate-source brea	akdown voltage	V (BR) GSS	$I_G = \pm 10 \ \mu A, \ V_{DS} = 0 \ V$	±30	_	_	V
Drain cut-off curr	ent	I _{DSS}	V _{DS} = 600 V, V _{GS} = 0 V	/_	_	100	μА
Drain-source bre	akdown voltage	V (BR) DSS	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	600	_	_	V
Gate threshold ve	oltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	2.0) / _	4.0	V
Drain-source ON	resistance	R _{DS} (ON)	V _{GS} = 10 V, I _D = 1.8 A	,) <u> </u>	1.7	2.2	Ω
Forward transfer	admittance	Y _{fs}	V _{DS} = 10 V, I _D = 1.8 A	0.7	2.5	_	S
Input capacitance	e	C _{iss}		_	550	_	
Reverse transfer capacitance		C _{rss}	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	7	6	_	pF
Output capacitance		Coss		_	60	_	
Switching time	Rise time	t _r	10 V I _D = 1.8 A V _{OUT} V _{GS}		12		
	Turn-on time	t _{on}	50Ω \$ RL =		45) —	no
	Fall time	t _f	V _{DD} ≈ 200 V	7	13		ns
	Turn-off time	t _{off}	Duty ≤ 1%, t _w = 10 μs		80	_	
Total gate charge	9	Qg) —	16	_	
Gate-source cha	rge	Q _{gs}	$V_{DD} \simeq 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 3.5 \text{ A}$	_	10	_	nC
Gate-drain charge Qgd		Qgd			6	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}		_	_	3.5	Α
Pulse drain reverse current (Note 1)	I _{DRP}	<u> </u>		_	14	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = 3.5 A, V _{GS} = 0 V	_	_	-1.7	V
Reverse recovery time	t _{rr}	I _{DR} = 3.5 A, V _{GS} = 0 V,	_	1400	_	ns
Reverse recovery charge	Q _{rr}	dl _{DR} /dt = 100 A/μs		9.0	_	μС

Marking

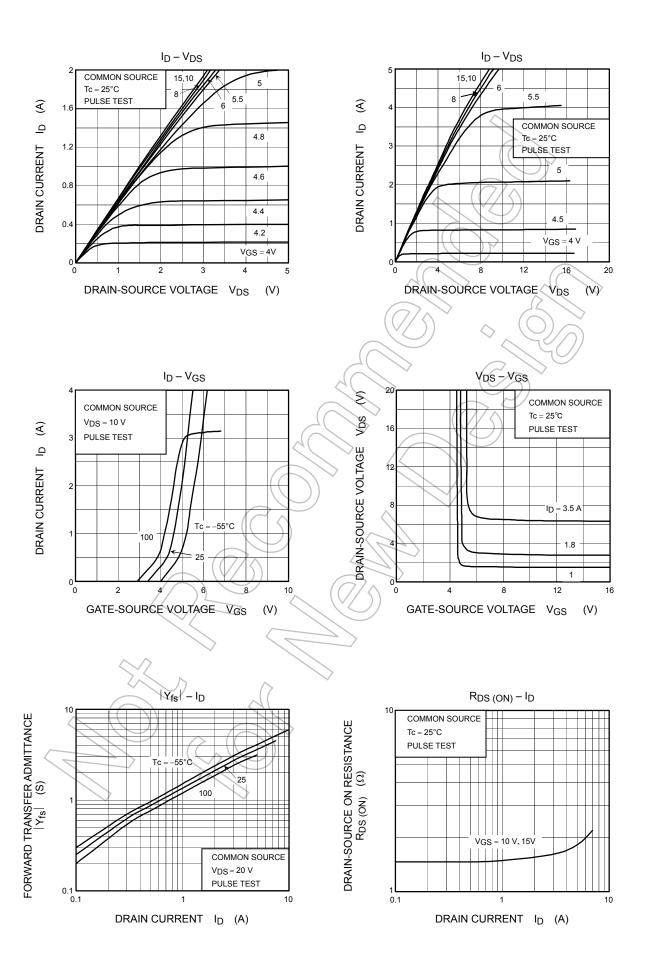


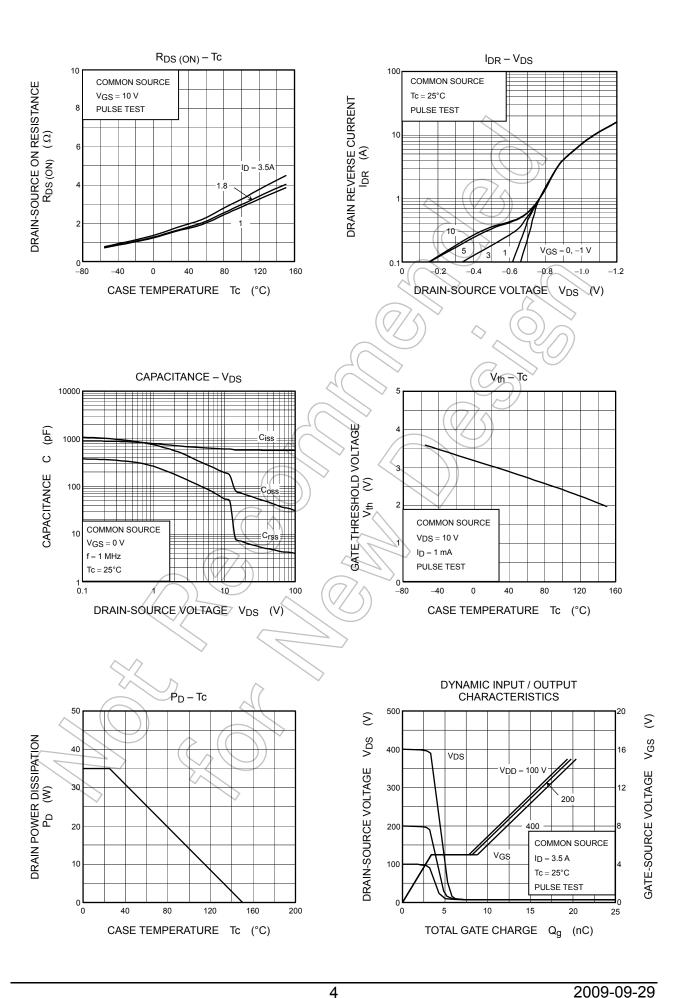
Note 4: A line under a Lot No. identifies the indication of product Labels.

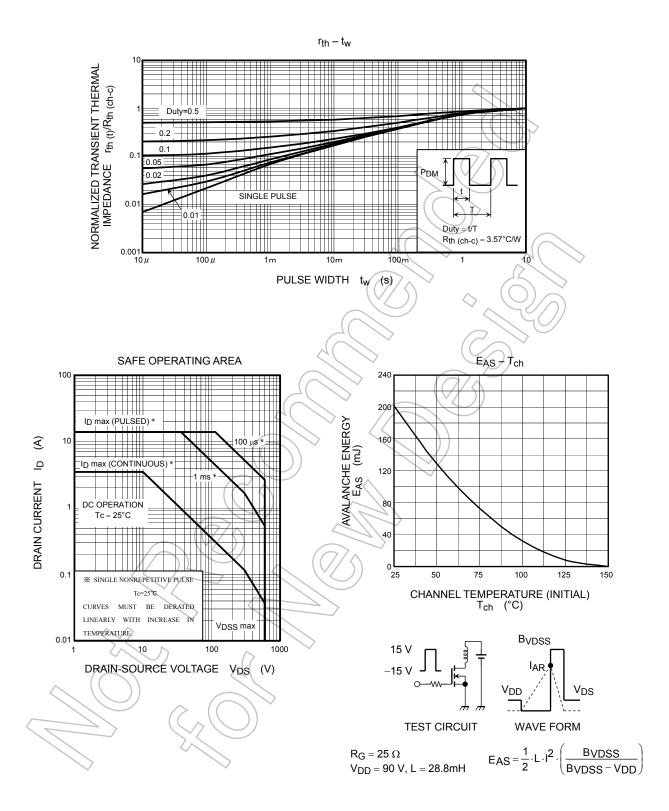
Not underlined: [[Pb]]/INCLUDES > MCV

Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

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